# **Low Voltage Comparators**

The NCS2200 Series is an industry first sub-one volt, low power comparator family. These devices consume only 10  $\mu$ A of supply current. They are guaranteed to operate at a low voltage of 0.85 V which allows them to be used in systems that require less than 1.0 V and are fully operational up to 6.0 V which makes them convenient for use in both 3.0 V and 5.0 V systems. Additional features include no output phase inversion with overdriven inputs, internal hysteresis, which allows for clean output switching, and rail-to-rail input and output performance. The NCS2200 Series is available in the tiny SOT-23-5 package. There are four options featuring two industry standard pinouts. Additionally, the NCS2200 and NCS2202 are available in the SC70-5 package. The NCS2200A is available in UDFN 1.2x1.0 package. (Table 1)

#### Features

- Operating Voltage of 0.85 V to 6.0 V
- Rail-to-Rail Input/Output Performance
- Low Supply Current of 10 μA
- No Phase Inversion with Overdriven Input Signals
- Glitchless Transitioning in or out of Tri-State Mode
- Complementary or Open Drain Output Configuration
- Internal Hysteresis
- Propagation Delay of 1.1 µs
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

#### **Typical Applications**

- Single Cell NiCd/NiMH Battery Powered Applications
- Cellular Telephones
- Alarm and Security Systems
- Personal Digital Assistants







**CASE 483** 



SC70-5 SQ SUFFIX CASE 419A



UDFN 1.2x1.0 MU SUFFIX CASE 517AA

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 12 of this data sheet.

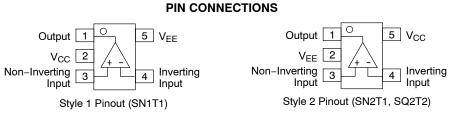
#### **DEVICE MARKING INFORMATION**

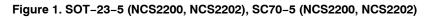
See general marking information in the device marking section on page 13 of this data sheet.

#### Table 1. Comparator Selector Guide

Output Type	Device	Package	Pinout Style
Complementary	NCS2200AMUT1G	UDFN, 1.2x1.0	N/A
Complementary	NCS2200SN1T1G	SOT-23-5	1
Complementary	NCV2200SN1T1G*	SOT-23-5	1
Complementary	NCS2200SN2T1G	SOT-23-5	2
Complementary	NCV2200SN2T1G*	SOT-23-5	2
Complementary	NCS2200SQ2T2G	SC70-5	2
Complementary	NCV2200SQ2T2G*	SC70-5	2
Complementary	NCS2200SQLT1G	DFN, 2x2.2	N/A
Open Drain	NCS2202SN1T1G	SOT-23-5	1
Open Drain	NCS2202SN2T1G	SOT-23-5	2
Open Drain	NCV2202SN2T1G*	SOT-23-5	2
Open Drain	NCS2202SQ1T2G	SC70-5	1
Open Drain	NCS2202SQ2T2G	SC70-5	2

\*NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.





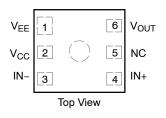


Figure 2. DFN 2x2.2 (NCS2200)

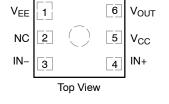


Figure 3. UDFN 1.2x1.0 (NCS2200A)

### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Supply Voltage Range (V <sub>CC</sub> to V <sub>EE</sub> )	VS	6.0	V
Non-inverting/Inverting Input to V <sub>EE</sub>	-	–0.2 to (V <sub>CC</sub> + 0.2)	V
Operating Junction Temperature	TJ	150	°C
Operating Ambient Temperature Range NCS2200, NCS2202, NCS2200A NCV2200, NCV2202	T <sub>A</sub>	-40 to +105 -40 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	−65 to +150	°C
Output Short Circuit Duration Time (Note 1)	t <sub>S</sub>	Indefinite	s
ESD Tolerance (Note 2) NCS2200 Human Body Model Machine Model NCS2202 Human Body Model Machine Model NCS2200A Human Body Model Machine Model	_	2000 200 1000 200 1900 200	V
Thermal Resistance, Junction-to-Ambient TSOP-5 DFN (Note 3) SC70-5 UDFN	$R_{ heta JA}$	238 215 283 350	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. The maximum package power dissipation limit must not be exceeded.

$$P_{D} = \frac{T_{J(max)} - T_{A}}{T_{J(max)} - T_{A}}$$

'D

 $PD = \frac{R_{\theta JA}}{R_{\theta JA}}$ 2. ESD data available upon request. 3. For more information, refer to application note, AND8080/D.

		NCS2200 Series			
Characteristics	Symbol	Min	Тур	Max	Unit
Input Hysteresis $T_A = 25^{\circ}C$	V <sub>HYS</sub>	2.0	8.0	20	mV
Input Offset Voltage V <sub>CC</sub> = 0.85 V	V <sub>IO</sub>				mV
$T_A = 25^{\circ}C$ $T_A = T_{Low}$ to $T_{High}$ (Note 5)		-10 -12	0.5 _	+10 +12	
$V_{CC} = 3.0 V$ $T_A = 25^{\circ}C$ $T_A = T_{Low}$ to $T_{High}$		-6.0 -8.0	0.5 _	+6.0 +8.0	
$V_{CC} = 6.0 V$ $T_A = 25^{\circ}C$ $T_A = T_{Low}$ to $T_{High}$		-5.0 -7.0	0.5	+5.0 +7.0	
Common Mode Voltage Range	V <sub>CM</sub>	_	$V_{EE}$ to $V_{CC}$	_	V
Output Leakage Current (NCS2202) $V_{CC} = 6.0 V$	ILEAK	_	3.3	_	nA
Output Short-Circuit Sourcing or Sinking (V <sub>out</sub> = GND)		_	70	_	mA
Common Mode Rejection Ratio $V_{CM} = V_{CC}$	CMRR	53	65	_	dB
	I <sub>IB</sub>	-	1.0	_	pA
Power Supply Rejection Ratio $\Delta V_{S} = 2.575 V$	PSRR	45	55	_	dB
Supply Current		45		_	
$V_{CC} = 0.85 V$ $T_A = 25^{\circ}C$	ICC	-	10	15	μΑ
$T_{A} = T_{Low} \text{ to } T_{High} \text{ (Note 5)}$ $V_{CC} = 3.0 \text{ V}$ $T_{A} = 25^{\circ}\text{C}$ $T_{VC} = T_{VC} \text{ to } T_{VC}  $		-	10	17 15 17	
$T_{A} = T_{Low} \text{ to } T_{High}$ $V_{CC} = 6.0 \text{ V}$ $T_{A} = 25^{\circ}\text{C}$ $T_{A} = T_{Low} \text{ to } T_{High}$		_	10	15 17	
Output Voltage High (NCS2200)	V <sub>OH</sub>				V
$V_{CC} = 0.85 \text{ V}, I_{source} = 0.5 \text{ mA}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High} \text{ (Note 5)}$	- 01	V <sub>CC</sub> – 0.2 V <sub>CC</sub> – 0.225	V <sub>CC</sub> – 0.10 –	-	
$V_{CC} = 3.0 \text{ V}, \text{ I}_{source} = 3.0 \text{ mA}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High}$		V <sub>CC</sub> - 0.2 V <sub>CC</sub> - 0.25	V <sub>CC</sub> – 0.12 –	-	
$V_{CC} = 6.0 \text{ V}, \text{ I}_{source} = 5.0 \text{ mA}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High}$		V <sub>CC</sub> - 0.2 V <sub>CC</sub> - 0.25	V <sub>CC</sub> – 0.12 –	-	
Output Voltage Low $V_{CC} = 0.85 \text{ V}, I_{sink} = 0.5 \text{ mA}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High} \text{ (Note 5)}$	V <sub>OL</sub>	-	V <sub>EE</sub> + 0.10	V <sub>EE</sub> + 0.2 V <sub>EE</sub> + 0.225	V
$V_{CC} = 3.0 \text{ V}, I_{sink} = 3.0 \text{ mA}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High}$		-	V <sub>EE</sub> + 0.12 -	V <sub>EE</sub> + 0.2 V <sub>EE</sub> + 0.25	
$V_{CC} = 6.0$ V, $I_{sink} = 5.0$ mA $T_A = 25^{\circ}C$ $T_A = T_{Low}$ to $T_{High}$		-	V <sub>EE</sub> + 0.12 -	V <sub>EE</sub> + 0.2 V <sub>EE</sub> + 0.25	
Propagation Delay 20 mV Overdrive, $C_L = 15 \text{ pF}$	t <sub>PHL</sub> t <sub>PLH</sub>		700 1100		ns
Output Fall Time $V_{CC}$ = 6.0 V, C <sub>L</sub> = 50 pF	t <sub>FALL</sub>	-	20	-	ns
Output Rise Time $V_{CC}$ = 6.0 V, $C_L$ = 50 pF	t <sub>RISE</sub>	-	16	_	ns
Powerup Time	t <sub>PU</sub>	_	35	_	μs

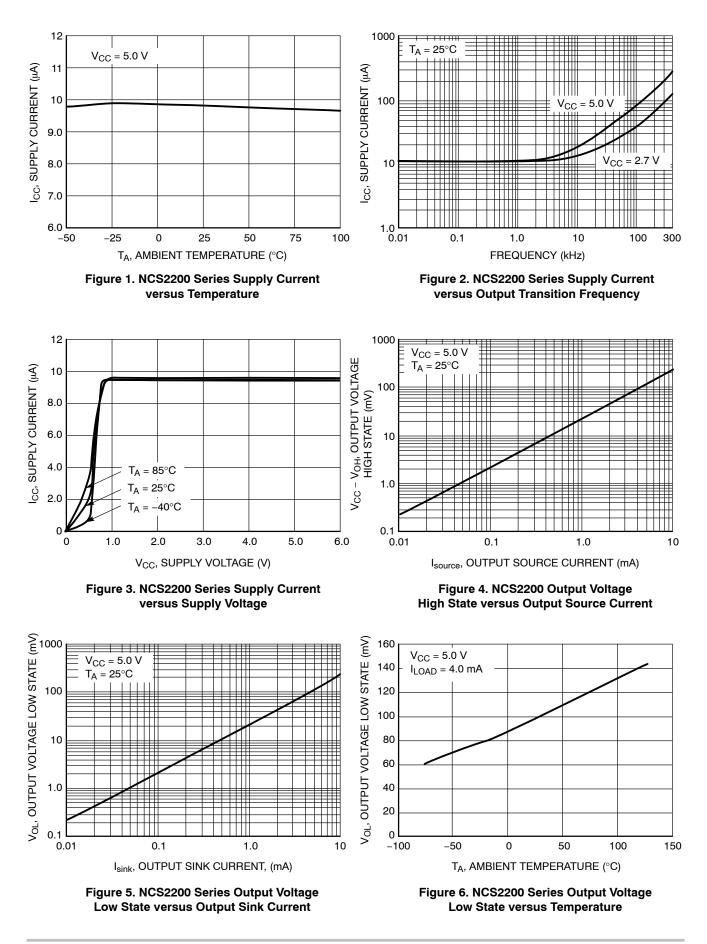
**ELECTRICAL CHARACTERISTICS** (For all values  $V_{CC} = 0.85$  V to 6.0 V,  $V_{EE} = 0$  V,  $T_A = 25^{\circ}C$ , unless otherwise noted.) (Note 4)

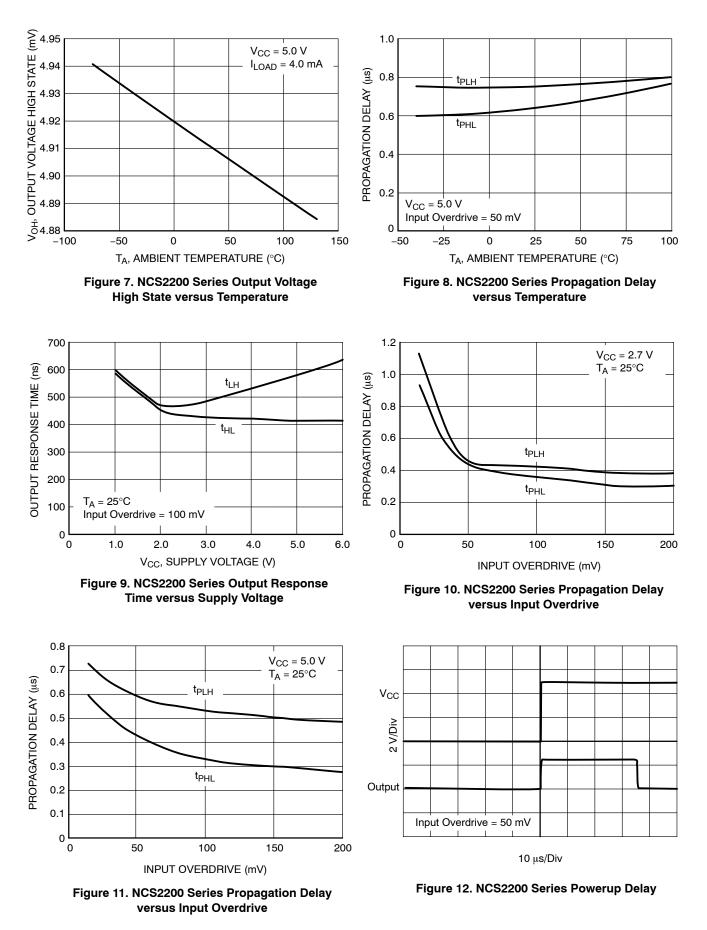
The limits over the extended temperature range are guaranteed by design only.
 NCS2200, NCS2202: T<sub>Low</sub> = -40°C, T<sub>High</sub> = +105°C; NCV2200, NCV2202: T<sub>Low</sub> = -40°C, T<sub>High</sub> = +125°C

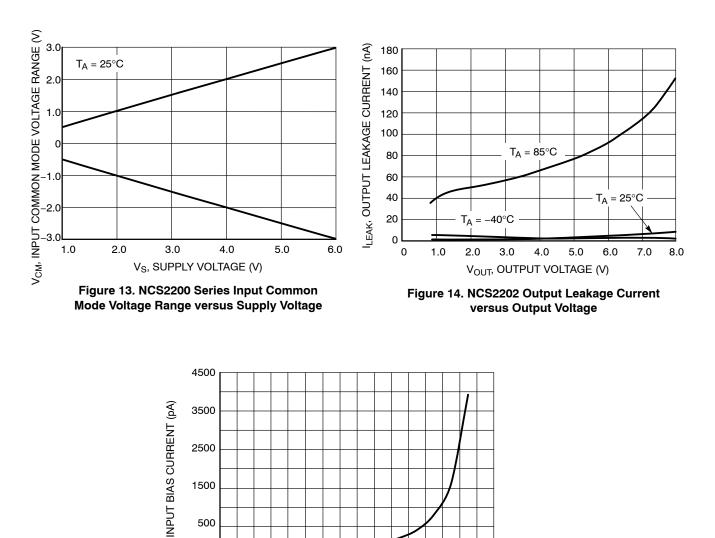
ELECTRICAL CHARACTERISTICS	(For all values $V_{CC}$ = 0.85 V to 6.0 V, $V_{EE}$ = 0 V, T	$T_A = 25^{\circ}C$ , unless otherwise noted.) (Note 6)
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			NCS2200A			
Characteristics	Symbol	Min	Тур	Max	Unit	
Input Hysteresis T <sub>A</sub> = 25°C	V <sub>HYS</sub>	2.0	4.5	20	mV	
Input Offset Voltage	V <sub>IO</sub>				mV	
$V_{\rm CC} = 0.85  \text{V}$						
$T_A = 25^{\circ}C$		-10	0.5	+10		
$T_A = -40^{\circ}C \text{ to } 105^{\circ}C$ $V_{CC} = 3.0 \text{ V}$		-12	_	+12		
$T_A = 25^{\circ}C$		-6.0	0.5	+6.0		
$T_A = -40^{\circ}C$ to $105^{\circ}C$		-8.0	-	+8.0		
$V_{CC} = 6.0 V$						
$T_{A} = 25^{\circ}C$		-5.0	0.5	+5.0		
$T_A = -40^\circ C$ to $105^\circ C$		-7.0	-	+7.0		
Common Mode Voltage Range	V <sub>CM</sub>	-	V <sub>EE</sub> to V <sub>CC</sub>	-	V	
Output Short–Circuit Sourcing or Sinking (V <sub>out</sub> = GND)	I <sub>SC</sub>	-	60	-	mA	
Common Mode Rejection Ratio V <sub>CM</sub> = V <sub>CC</sub>	CMRR	53	70	-	dB	
Input Bias Current	I <sub>IB</sub>	-	1.0	-	pА	
Power Supply Rejection Ratio $\Delta V_S = 2.575 V$	PSRR	45	80	-	dB	
Supply Current	Icc				μA	
$V_{CC} = 0.85 V$ $T_{A} = 25^{\circ}C$			7.5	15		
$T_A = -40^{\circ}$ C to 105°C			-	17		
$V_{CC} = 3.0 V$						
$T_A = 25^{\circ}C$		-	8.0	15		
$T_A = -40^{\circ}C$ to $105^{\circ}C$			-	17		
$V_{\rm CC} = 6.0  \text{V}$			0.0	15		
$T_A = 25^{\circ}C$ $T_A = -40^{\circ}C$ to 105°C		-	9.0	15 17		
Output Voltage High	V <sub>OH</sub>				V	
$V_{CC} = 0.85 \text{ V}, \text{ I}_{\text{source}} = 0.5 \text{ mA}$	VОН				v	
$T_A = 25^{\circ}C$		V <sub>CC</sub> – 0.25	V <sub>CC</sub> – 0.10	-		
$T_A = -40^{\circ}C$ to $105^{\circ}C$		V <sub>CC</sub> – 0.275	-			
$V_{CC} = 3.0 \text{ V}, \text{ I}_{\text{source}} = 3.0 \text{ mA}$						
$T_A = 25^{\circ}C$ $T_A = -40^{\circ}C$ to $105^{\circ}C$		V <sub>CC</sub> – 0.3	V <sub>CC</sub> – 0.12	-		
$V_{CC} = 6.0 \text{ V}, I_{source} = 5.0 \text{ mA}$		V <sub>CC</sub> – 0.35	_			
$T_A = 25^{\circ}C$		V <sub>CC</sub> – 0.3	V <sub>CC</sub> – 0.12	-		
$T_A = -40^{\circ}C$ to $105^{\circ}C$		V <sub>CC</sub> – 0.35	-			
Output Voltage Low	V <sub>OL</sub>				V	
$V_{CC} = 0.85 \text{ V}, \text{ I}_{sink} = 0.5 \text{ mA}$						
$T_A = 25^{\circ}C$		-	V <sub>EE</sub> + 0.10	V <sub>EE</sub> + 0.25		
$T_A = -40^{\circ}C$ to 105°C V <sub>CC</sub> = 3.0 V, I <sub>sink</sub> = 3.0 mA			_	V <sub>EE</sub> + 0.275		
$T_A = 25^{\circ}C$		-	V <sub>EE</sub> + 0.12	V <sub>EE</sub> + 0.3		
$T_{A} = -40^{\circ}C$ to 105°C				V <sub>EE</sub> + 0.35		
$V_{\rm CC} = 6.0 \text{ V}, \text{ I}_{\rm sink} = 5.0 \text{ mA}$						
$T_{A} = 25^{\circ}C$		-	V <sub>EE</sub> + 0.12	V <sub>EE</sub> + 0.3		
$T_{A} = -40^{\circ}C \text{ to } 105^{\circ}C$			-	V <sub>EE</sub> + 0.35		
Propagation Delay 20 mV Overdrive, $C_L = 15 \text{ pF}$	t <sub>PHL</sub> t <sub>PLH</sub>	-	460 500	-	ns	
Propagation Delay 20 mV Overdrive, C <sub>L</sub> = 15 pF, 2.85 V						
Fropagation Delay 20 mv Overanve, OL = 15 pF, 2.85 V	t <sub>PHL</sub> t <sub>PLH</sub>	-	410 500	-	ns	
Propagation Delay 50 mV Overdrive, $C_L = 15 \text{ pF}$ , 2.85 V	t <sub>PHL</sub>	_	280	_	ns	
$\frac{1}{2} = \frac{1}{2} = \frac{1}$	t <sub>PLH</sub>	-	350	-	113	
Propagation Delay 100 mV Overdrive, C <sub>L</sub> = 15 pF, 2.85 V	t <sub>PHL</sub>	-	230	-	ns	
	t <sub>PLH</sub>	-	300	-		
Output Fall Time $V_{CC}$ = 6.0 V, $C_L$ = 50 pF (Note 7)	t <sub>FALL</sub>	-	20	-	ns	
Output Rise Time $V_{CC}$ = 6.0 V, $C_L$ = 50 pF (Note 7)	t <sub>RISE</sub>	-	16	-	ns	

6. The limits over the extended temperature range are guaranteed by design only.7. Input signal: 1 kHz, squarewave signal with 10 ns edge rate.





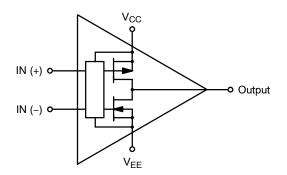


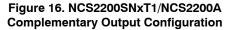
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TEMPERATURE (°C) Figure 15.

#### **OPERATING DESCRIPTION**

The NCS2200 Series is an industry first sub-one volt, low power comparator family. This series is designed for rail-to-rail input and output performance. These devices consume only 10  $\mu$ A of supply current while achieving a typical propagation delay of 1.1  $\mu$ s at a 20 mV input overdrive. Figures 10 and 11 show propagation delay with various input overdrives. This comparator family is guaranteed to operate at a low voltage of 0.85 V up to 6.0 V. This is accomplished by the use of a modified analog CMOS process that implements depletion MOSFET devices. The common-mode input voltage range extends 0.1 V beyond the upper and lower rail without phase inversion or other adverse effects. This series is available in the SOT-23-5





package. Additionally, the NCS2200 device is available in the tiny DFN 2x2.2 package and the SC70–5 package. NCS2200A is available in UDFN package.

#### **Output Stage**

The NCS2200 has a complementary P and N Channel output stage that has capability of driving a rail-to-rail output swing with a load ranging up to 5.0 mA. It is designed such that shoot-through current is minimized while switching. This feature eliminates the need for bypass capacitors under most circumstances.

The NCS2202 has an open drain N-channel output stage that can be pulled up to 6.0 V (max) with an external resistor. This facilitates mixed voltage system applications.

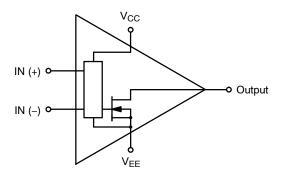
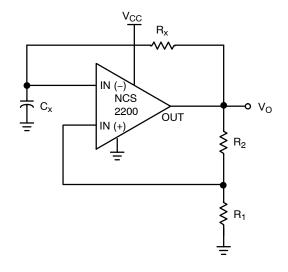


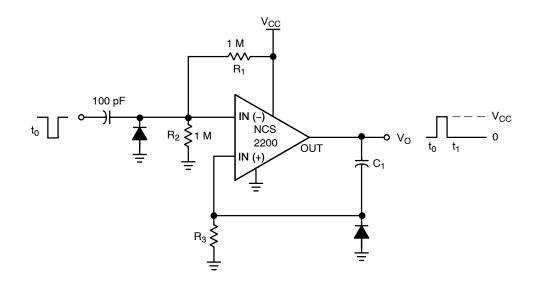
Figure 17. NCS2202SNxT1 Open Drain Output Configuration



The oscillation frequency can be programmed as follows:

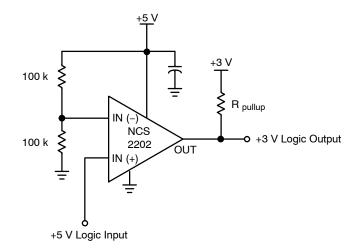
$$f=\frac{1}{T}=\frac{1}{2.2\ R_X C_X}$$

Figure 18. Schmitt Trigger Oscillator



The resistor divider  $R_1$  and  $R_2$  can be used to set the magnitude of the input pulse. The pulse width is set by adjusting  $C_1$  and  $R_3$ .

Figure 19. One-Shot Multivibrator



This circuit converts 5 V logic to 3 V logic. Using the NCS2202/3 allows for full 5 V logic swing without creating overvoltage on the 3 V logic input.



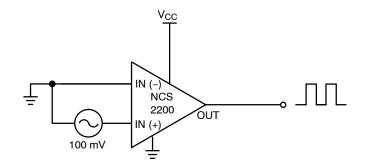


Figure 21. Zero-Crossing Detector

#### **ORDERING INFORMATION**

Device	Pinout Style	Output Type	Package	Shipping <sup>†</sup>
NCS2200AMUT1G	N/A	Complementary	UDFN (Pb-Free)	3000 / Tape & Reel
NCS2200SN1T1G	1	Complementary	SOT-23-5 (TSOP-5) (Pb-Free)	3000 / Tape & Reel
NCV2200SN1T1G*	1	Complementary	SOT-23-5 (TSOP-5) (Pb-Free)	3000 / Tape & Reel
NCS2200SN2T1G	2	Complementary	SOT-23-5 (TSOP-5) (Pb-Free)	3000 / Tape & Reel
NCV2200SN2T1G*	2	Complementary	SOT-23-5 (TSOP-5) (Pb-Free)	3000 / Tape & Reel
NCS2200SQ2T2G	2	Complementary	SC70-5 (Pb-Free)	3000 / Tape & Reel
NCV2200SQ2T2G*	2	Complementary	SC70–5 (Pb–Free)	3000 / Tape & Reel
NCS2200SQLT1G	N/A	Complementary	DFN, 2x2.2 (Pb-Free)	3000 / Tape & Reel
NCS2202SN1T1G	1	Open Drain	SOT-23-5 (TSOP-5) (Pb-Free)	3000 / Tape & Reel
NCS2202SN2T1G	2	Open Drain	SOT-23-5 (TSOP-5) (Pb-Free)	3000 / Tape & Reel
NCV2202SN2T1G*	2	Open Drain	SOT-23-5 (TSOP-5) (Pb-Free)	3000 / Tape & Reel
NCS2202SQ1T2G	1	Open Drain	SC70–5 (Pb–Free)	3000 / Tape & Reel
NCS2202SQ2T2G	2	Open Drain	SC70–5 (Pb–Free)	3000 / Tape & Reel

This device contains 93 active transistors.

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. \*NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and

PPAP Capable.

#### MARKING DIAGRAMS



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	С	A۷	( A	Y	W	•
	•		•			
1						

- x = I for NCS2200SN1T1 J for NCS2200SN2T1 M for NCS2202SN1T1 N for NCS2202SN2T1
- A = Assembly Location

Y = Year

- W = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)





CB = Specific Device Code

N

= Pb–Free Package

(Note: Microdot may be in either location)

\*Date Code overbar and underbar may vary depending upon manufacturing location.





CBx	=	Specific Device Code
х	=	A for NCS2200SQ2T2
		D for NCS2202SQ1T2G
		E for NCS2202SQ2T2G
М	=	Date Code*

Pb-Free Package

(Note: Microdot may be in either location) \*Date Code orientation, position, and underbar may vary depending upon manufacturing location.





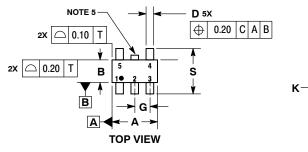
(Top View)

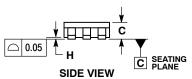
- S = Specific Device Code
- M = Date Code
- = Pb–Free Package

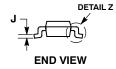
#### SOT-23-5 / TSOP-5 / SC59-5 **SN SUFFIX** CASE 483-02 **ISSUE K**

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME
- 2 3.
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS. SHALL NOT EXCEED 0.15 PER SIDE. DIMENSION A. OPTIONAL CONSTRUCTION: AN ADDITIONAL TRIMMED LEAD IS ALLOWED IN THIS LOCATION. TRIMMED LEAD NOT TO EXTEND MORE THAN 0.2 FROM BODY. 4.
- 5.

FROM BODY.				
	MILLIN	IETERS		
DIM	MIN	MAX		
Α	3.00	BSC		
В	1.50	BSC		
С	0.90	1.10		
D	0.25	0.50		
G	0.95	BSC		
Н	0.01	0.10		
J	0.10	0.26		
к	0.20 0.60			
м	0° 10°			
S	2.50	3.00		

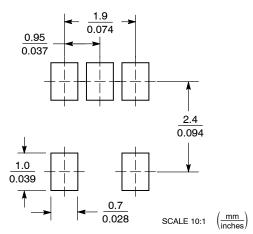






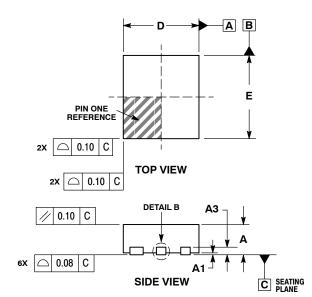
DETAIL Z

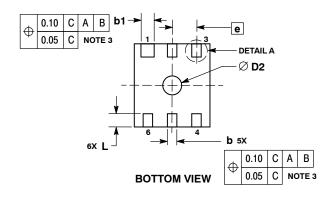
#### **SOLDERING FOOTPRINT\***

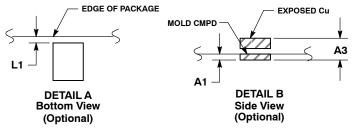


\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DFN6, 2x2.2 SQL SUFFIX CASE 488-03 ISSUE G



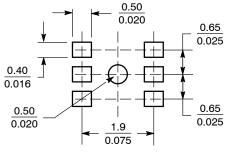




- NOTES:
   DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
   CONTROLLING DIMENSION: MILLIMETERS.
   DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30mm FROM TERMINAL
   COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
   TERMINAL & MAY HAVE MOLD COMPOUND MATERIAL ALONG SIDE EDGE.
   DETAILS A AND B SHOW OPTIONAL VIEWS
- 6. DETAILS A AND B SHOW OPTIONAL VIEWS FOR END OF TERMINAL LEAD AT EDGE OF PACKAGE AND SIDE EDGE OF PACKAGE.

	MILLIMETERS					
DIM	MIN NOM MAX					
Α	0.80	0.90	1.00			
A1	0.00	0.03	0.05			
A3	0.20 REF					
q	0.20	0.25	0.30			
b1	0.30	0.35	0.40			
D		2.00 BSC				
D2	0.40	0.50	0.60			
Е		2.20 BSC				
e	0.65 BSC					
L	0.30	0.35	0.40			
L1	0.00	0.05	0.10			

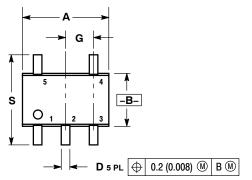
**SOLDERING FOOTPRINT\*** 

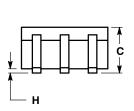


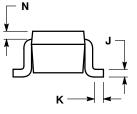
SCALE 10:1

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

SC-88A (SC-70-5/SOT-353) SQ SUFFIX CASE 419A-02 **ISSUE L** 





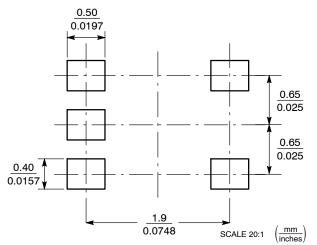


- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. 419A-01 OBSOLETE. NEW STANDARD 419A-02. CDMENSIONS & AND B DO NOT INCLUD 4.

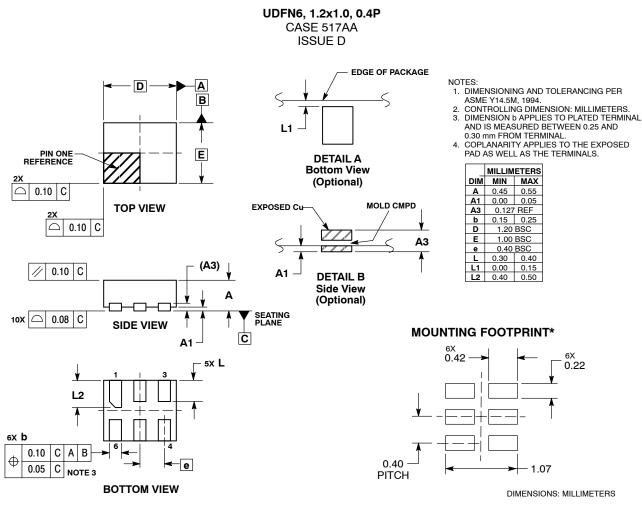
DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	INCHES		MILLIM	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.071	0.087	1.80	2.20
В	0.045	0.053	1.15	1.35
С	0.031	0.043	0.80	1.10
D	0.004	0.012	0.10	0.30
G	0.026	BSC	0.65 BSC	
Н		0.004		0.10
J	0.004	0.010	0.10	0.25
Κ	0.004	0.012	0.10	0.30
Ν	0.008	B REF	0.20	REF
S	0.079	0.087	2.00	2.20





\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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